## SUPPORT FOR AMENDMENTS

The amendment to Claim 1 is supported by original Claim 5. New Claims 11-23 are supported by the original claims and the specification as originally filed. With regard to Claims 19, 20 and 23 see page 13, lines 29-32. No new matter has been entered.

## **REMARKS**

Applicants note that an IDS/List of Related Cases was filed on April 18, 2003.

Applicants respectfully request that this IDS be considered and noted in the next Office letter.

The present invention relates generally to radiation sensitive compositions and their uses in organic EL display elements. As noted by the above amendment to original Claim 1, the composition therein described requires an alkali-soluble resin having no epoxy group, a 1,2-quinonediazide compound, and at least one compound selected from the group consisting of a melamine compound and an epoxy compound. This claim has been rejected as being anticipated by Japan 59-184337 (<u>JP '337</u>), however, the reference fails to disclose the presence of a melamine compound or an epoxy compound, as now required. Instead, the reference describes a photosensitive heat resistant material containing a resin having the structure as follows:

$$\begin{array}{c|c} OH & OH \\ \hline \\ CH_{2} & CH_{2} \\ \hline \end{array}$$

where n is from 0 to 10.

In addition to the lack of a melamine compound and an epoxy compound in <u>JP '337</u>, the reference further lacks an alkali-soluble resin <u>having an epoxy group</u>. Such an element is

required as element (a') in Claim 6, and for this reason <u>JP '337</u> should not be applied to this claim, or claims dependent thereon.

Finally, the Examiner will note new Claim 16. While generally similar in composition components to original Claim 1, this claim is directed to an organic EL display element that is neither disclosed or suggested by the reference.

Because <u>JP '337</u> neither discloses nor suggests the invention as claimed in any of the pending claims Applicants respectfully request the reconsideration and withdrawal of the outstanding rejection over this reference, and the passage of this case to Issue. As noted above, it is respectfully requested that the Notice of Allowance include an indication that the IDS/List of Related Cases filed April 18, 2003, was considered.

Respectfully submitted,

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## IN THE CLAIMS

Please amend the claims as follows:

1. (Amended) A radiation sensitive resin composition, comprising [(1), (a)] an alkali-soluble resin having no epoxy group. [and (b)] a 1,2-quinonediazide compound, and [(2) being for forming an insulating film for an organic EL display element] at least one compound selected from the group consisting of a melamine compound and an epoxy compound.

Claim 5 (Canceled).

- 6. (Amended) A radiation sensitive resin composition, comprising [(1),] (a') an alkali-soluble resin having an epoxy group and (b) a 1,2-quinonediazide compound[,and (2) being for forming an insulating film for an organic EL display element].
- 8. (Amended) An insulating film for an organic EL display element, formed from the radiation sensitive resin composition of claim 1 [or 6].

Claims 9 and 10 (Canceled).

Claims 11-23 (New).